



PKG. DIMENSIONS(MM)		
SYMBOL	Min	Max
A		0.625
A1	0.18	0.22
D	1.84	1.90
e	0.50 BSC	
E	1.34	1.40
b	0.24	0.28
ccc	0.05 TYP	
ddd	0.015 TYP	

Notes:
1. Ref:JEDEC MO-211C



DATE: 05/18/17

DESCRIPTION: 12-Pin, CSP, 1.37X1.87, Wafer Level

PACKAGE CODE: GAA (GAA12)

DOCUMENT CONTROL#: PD-2229

REVISION: --